

» CP6001 «



6U Intel® Core™2 Duo Rugged Processor Blade

- » High computing and graphic performance ULV and LV Intel® Core™2 Duo processors combined with 945 chipset
- » Three Rugged Levels R1, R2, R3 for demanding application requirements High shock and vibration resistant and conduction cooled versions
- » Comprehensive I/O capabilities
 3x GbE, 4x SATA, 2x DVI, onboard HDD, Flash ...

CP6001

6U Intel® Core™2 Duo Rugged Processor Blade

Explore the power and the potential of two cores in one processor with Kontron's CP6001 based on the Intel® Core™ Duo / Core™ 2 Duo processor.

The CP6001, a CompactPCI PICMG 2.16 compliant 6U CPU board, comes with three rugged levels, making it yet another addition to Kontron's rugged PICMG 2.16 portfolio. Based on the Intel® Core™ Duo / Core™ 2 Duo processor and mobile chipset, the CP6001 features high computing and graphic performance with a low thermal power design and a complete set of data, communication and multimedia interfaces.

>> Maximum Ruggedization

Designed to withstand even the toughest environmental conditions, the passively cooled CP6001 featuring up to 4 GByte of soldered RAM and 2 GByte of soldered application flash comes in three rugged levels - defined as R1, R2 and R3. Versions R2 and R3 are available with E2 capabilities on project request (extended temperature range from -40° C to +85° C). The R1 version is designed for standard application requirements in air-cooled environments. The R2 version is ruggedized for high shock and vibration, air-cooled environments up to, and including VITA 47's EAC3/EAC6 (EAC6 requires special system components). The R3 version is fully conduction cooled and meets the VITA 47's ECC4 requirements. The CP6001 features energy efficient embedded Intel®

dual core processors. With the 1.2 GHz Intel® Core™ Duo U2500 ULV processor and the Intel® Core™ 2 Duo L7400 LV processor, the CP6001 has extraordinary performance-per-watt values. Based on the Intel® Mobile 945GM chipset with a front side bus of up to 667 MHz and ICH7-R Southbridge, the CP6001 provides high graphics performance for the two independent digital video outputs to the rear I/O as well as HDA audio capabilities.

>> Comprehensive Versatility

The CP6001 offers comprehensive I/O capability with 3 x GbEthernet, 4 x SATA with RAID 0/1/5/10 functionality as well as 6 x USB 2.0, 2 x COM and VGA and/or DVI. It can also accommodate a PMC slot or an onboard 2.5" SATA HDD. With up to 8 GByte of USB or 2 GByte soldered flash, the CP6001 enables construction of a highly shock and vibration resistant system with non-rotating, non-volatile memory.

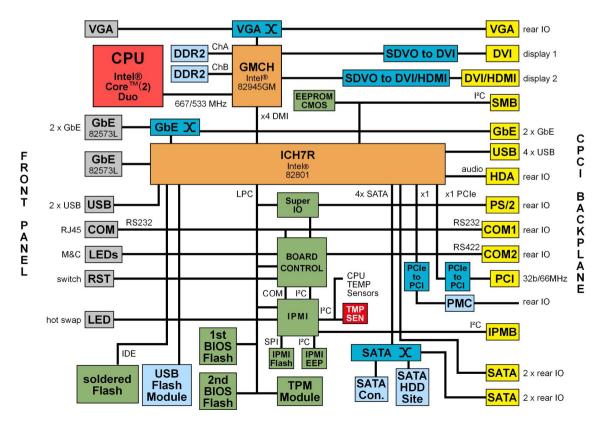
>> Unique Security

The board provides safety and security via a trusted platform module, (TPM) 1.2, two redundant 8 Mbit firmware hubs (failover) and IPMI (Intelligent Platform Management Interface) support (PICMG 2.9 R1.0).

>> Long-term Availability

Delivering a stable product based on Intel®'s embedded product line the CP6001 ensures long-term availability.





Processor	Intel® Core™(2) Duo	Processor (65nm):			
Flocessor	Intel® Core™(2) Duo Processor (66nm): - Core™ Duo U2500, 1.2 GHz, 533 MHz FSB, 2 MB L2 cache, (ULV) - Core™2 Duo L7400, 1.5 GHz, 667 MHz FSB, 4 MB L2 cache, (LV) Note: Versions incorporating other CPUs available on project request. Please contact us for further assistance.				
Chipset	- GMCH Intel® 945GM, dual-channel DDR-2 memory controller, intern. graphics controller w. dual indep. graphic channels - I/O Hub Intel® ICH7R, 4 SATA II controllers, 7 x USB 2.0 (used 6 x USB), 6 x PCIe x1 (used 5 x PCIe x1), 1 x LPC				
Memory	- Up to 4 GByte DDR-2, 533/667MHz, w/o ECC, 2 channels: 2 GB soldered + 2 GB soldered - Up to 4 GB NAND soldered Flash with onboard CompactFlash controller - Two redundant 8 Mbit Firmware Hubs (FWH)				
Onboard Controller			IOS data when operating without batto Ethernet PCI Express bus controllers:	ery	
onboard controller	 - Ix fixed to front I/O - 2x selectable between front or rear I/O to support PICMG 2.16 - Watchdog: FPGA-based, software configurable, two-stage Watchdog w. programmable timeout ranging from 125 ms to 256 s in 12 steps - RTC, integrated in ICH7R - IPMI Controller, Renesas H8S/2166 controller w. on-chip 512 kB Flash and 40 kB RAM; ext. 1 MB SPI Flash, 64 kbit EEPRO - Super I/O: LPC Super I/O from SMSC SCH3112I-NU, 2x UART, HW-Monitor, PS2, fan control - Trusted Platform Module (TPM): Infineon SLB 9635 TT 1.2 				
System Interconnect	- COM1 as RS232 (- COM2 as RS422 (- USB NAND Flash: Or can be connected (- SATA: Four Serial A' - Two ports are ro (- Two are selectab (- One onboard S (- One available (- One available (- COM2	IA II ports Ited to rear I/O le between rear I/O or onbo ATA interface routed to a st as 2.5" onboard HDD (mutu	routed to a dedicated onboard conne oard usage: tandard SATA connector		
Front Panel Functions	(Note: CP6001-R3- c	onduction cooled- with red	uced front I/0)		
Ethernet	3 x 1000/100/10 Ba				
VGA	1 x 15-Pin D-Sub connector for standard analog displays				
COM	1x RS232 UART interface on RJ45 connector				
USB	2x 4-pin connectors				
PMC	opening for PMC front panel (R1 only)				
LEDs	2x LAN activity (yellow) and speed (green), one blue control LED for hot swap, 2x for IPMI, 1x watchdog, 1x thermal control LED-field for BIOS POST code or general purpose				
Reset	reset button, guarde	d			
Micro switch	for hot swap				
I/O Table Summary					
	Front I/O	Rear I/0	Onboard Connector	Total	
Video	1 (*)	2	<u>-</u>	2	
USB	2 (*)	4	<u>-</u>	6	
Serial	1 (*)	2		2	
PS/2 Mouse/Kbd		1		1	
Ethernet	3 (*)	2	<u>-</u>	3	
SATA	-	4	2	4	
USB-Flash	4 CCMC CDC004 D		1 Put (Pu 2 (Pu)	1	
PMC	1 CCMC on CP6001-R		Pn1/Pn2/Pn4	1	
	*) not available on (CP6001-R3			
CompactPCI Bus Interface Rear I/O via J3/J4/J5	- Operating in system	, REQ/GNT for 7 slots n slot as system master and A, COM 1/2, keyboard, mou	d in peripheral slot in PCI passive mod use, USB 3-6, HDA, speaker, FAN sense		
IPMI	IPMI 1.5 compliant	прмт			
Compliancy	- CompactPCI Core Specification PICMG 2.0 Rev. 3.0 - CompactPCI Hot Swap Specification PICMG 2.1 R2.0 - CompactPCI System Management PICMG 2.9 R1.0 - CompactPCI Packet Switching Backplane PICMG 2.16 R1.0 Designed to meet or exceed: - Safety: UL 1950, UL 94, CSA 22.2 No 950, EN 60950, IEC 950 - EMI/EMC: EN 55022 / EN 55024, EN 50081-1 / EN 6100-6-2				
General	- Dimensions: 233 x 160 x 20.5 mm, 6U, 4HP - Weight: R1: 622g; R2: 740g; R3: 698g - MBTF: 180,332 h acc. to MIL-HDBK 217FN2, Ground Benign GB controlled at 30°C - CP6001-R3 214881 h acc. to MIL-HDBK-217 FN2 Ground Benign 30°				
Software Support	 - AMI BIOS with POST codes - Setup console redirection to serial port (VT100 mode) with CMOS setup access - BIOS parameters saved in EEPROM - Diskless, keyboardless, videoless operation, LAN boot support - Board identification number accessible via EEPROM - Support for Windows® XP, XP Embedded, Linux®, VxWorks® (other OSs may be possible, please contact us for information) 				
Power Consumption	- U2500 ULV 1.2 GHz and 1GB memory: max. 23W - L7400 LV 1.5 GHz and 4GB memory: max. 35 W				
Environmental	- CP6001-R2: R1 + VI - CP6001-R3: VITA 47 MIL-ST MIL-ST	TA 47, EAC3/EAC6; normal a r, class ECC4 D-810 Method 514 Proc 1 D-810 Method 516 Proc 1	EC 61131-2; (0° to 60°C, forced air co and extended (-40° to +85°C, forced a		
		ed (-40 to +85°C, conduction pration levels can be achiev	on cooling required) red when installed in a ruggedized sys	tem.	

Article	Order-No.	Description	
CPU Boards			
CP6001-R1-1.2-2G	1022-9809	R1-Level, Intel® Core™ Duo U2500 ULV 1.2 GHz, 2GB soldered Memory	
CP6001-R1-1.5-2G	36874	R1-Level, Intel® Core™2 Duo L7400 LV 1.5 GHz, 2GB soldered Memory	
CP6001-R1-1.5-4G	37139	R1-Level, Intel® Core™2 Duo L7400 LV 1.5 GHz, 4GB soldered Memory 5)	
CP6001-R2-1.2-2G-E2 1)	1022-8743	R2-Level, Intel® Core™ Duo U2500 ULV 1.2 GHz, 2GB soldered Memory, E2 (-40°C to +85°C)	
CP6001-R2-1.5-2G-E1x 1)	1022-9327	R2-Level, Intel® Core™2 Duo L7400 LV 1.5 GHz, 2GB soldered Memory, E1x (-40°C to +70°C)	
CP6001-R3-1.2-2G-4GF-E2 1)	1022-9810	R3-Level, Intel® Core™ Duo U2500 ULV 1.2 GHz, 2GB soldered Memory, E2 (-40°C to +85°C)	
CP6001-R3-1.5-2G-4GF-E1x 1)	1022-3238	R3 Level, Intel® Core™2 Duo L7400 1.5 GHz, 2GB soldered Memory, E1x (-40°C to +70°C)	
USB-Flash Modules			
FLASH-USB-2GB	35953	USB-Module, low Profile, 2GByte	
FLASH-USB-4GB	35954	USB-Module, low Profile, 4GByte	
FLASH-USB-8GB	1022-5515	USB-Module, low Profile, 8GByte	
Services	_		
CP6001-MK2.5SATA ^{2) 3)}	37248	Mounting kit for 2,5" SATA-HDD onboard, mounting within 4HP	
Rear Transition Modules			
CP-CTM80-3	29973	Various 4HP versions available	
CP-RI06-001	37459	With 2xDVI-D; 2xUSB2.0; 2xGbE; headers for 2xCOM, Flash, SATA, fan	
	37460	With 1xDVI-D; 2xUSB2.0; 2xGbE; socket for SATA 2.5" disk; headers for 2xCOM, Flash, SATA, fan	
Software Support	_		
KIT-CP6001 ⁴⁾	36894	Documentation and Windows driver kit on CD-ROM	
WXPE-BSP-CP6001 ⁴⁾	1022-7603	Windows XP Embedded BSP CP6001	
LIN-BSP-CP6001 4)	36895	Linux BSP CP6001 for Suse and RedHat	
VXW-BSP-CP6001	36896	VxWorks BSP 6.6 SMP support	
Notes:	1) No onboard HDD possible, only conduction cooled PMC. 2) Mounting kit CP6001-MK2.5SATA for -R1 version only; mutually exclusive with PMC slot usage. 3) HDD must be ordered separately. 4) Free of charge, downloadable from the Internet. 5) Physical memory available for applications is less. Please contact your local sales representative for other configuration options.		



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